



3RD GENERATION
PARTNERSHIP
PROJECT 2
"3GPP2"

TSG CORRESPONDENCE

Mr. Norikazu Yamasaki
Chair, 3GPP2 TSG-S
KDDI Corporation
Garden Air Tower
3-10-10 Iidabashi
Chiyoda-ku, Tokyo 102-8460, Japan
nr-yamasaki@kddi.com

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Mr. Christian Toche
Chair, 3GPP TSG-SA WG5
Huawei Technologies CO., LTD
Pudong Lujiazui Software Park; No.98,
Lane91, Eshan Road,
Pudong New District,
Shanghai, 200127, P.R.C.
Christian.Toche@huawei.com

RE: XSD Subclassing & IMS Harmonization

Dear Mr. Toche,

In the context of keeping 3GPP SA5 abreast of current activities and work in progress, 3GPP2 TSG-S WG5 has attached three contributions representing current discussions relating to XSD subclassing, XSD guidelines as well as IMS harmonization.

1. Attachments S00-20060626-109A and S00-20060626-109B represent two different proposals for providing XSD subclassing. In addition, attachment S00-20060626-109A includes a preliminary 3GPP R6 TS 32.150 input for XSD guidelines.
2. Attachment S00-20060626-109C updates S50-20060116-009 previously sent to 3GPP SA5 (provided within our Liaison from 23 February 2006). It has been updated to reference the latest 3GPP SA5 R6 specifications and to propose the list of IMS-specific IOCs.

3GPP2 TSG-S would appreciate consideration of these aspects of concern and welcome further discussions. If you have additional questions, please contact: Randy Scheer (rjscheer@lucent.com).

Regards,

山崎徳和

Norikazu Yamasaki
Chair, 3GPP2 TSG-S

cc:	Y.K. Kim	Chair, 3GPP2 SC	ykkim@lgtel.co.kr
	Henry Cuschieri	3GPP2 Secretariat	hcuschieri@tiaonline.org
	Victoria Bosserman	3GPP2 Secretariat	ybosserman@tiaonline.org
	Stephen Hayes	Chair, 3GPP TSG-SA	stephen.hayes@ericsson.com

Attachments

S00-20060626-109A__Lucent_XSD_Subclassing (S50-20060530-002).zip
S00-20060626-109B__Lucent_XSD_Subclassing_Extension (S50-20060626-006).zip
S00-20060626-109C__Lucent_IMS_Comparison (S50-20060626-005R2).zip